

# **Design of the Telescopic OTA**

**For a Generic 180nm Bulk CMOS Process (Version 2)**

Christian Enz (christian.enz@epfl.ch)

2025-07-25

# Table of contents

<b>1</b>	<b>Introduction</b>	<b>3</b>
<b>2</b>	<b>Analysis</b>	<b>5</b>
2.1	Small-signal analysis . . . . .	5
2.2	Noise Analysis . . . . .	6
2.2.1	Input-referred thermal noise . . . . .	7
2.2.2	Input-referred flicker noise . . . . .	7
2.3	Input-referred offset voltage . . . . .	8
<b>3</b>	<b>Design</b>	<b>10</b>
3.1	Specifications . . . . .	10
3.2	Process . . . . .	10
3.3	Design procedure . . . . .	11
3.4	Sizing of $M_{1a}$ - $M_{1b}$ . . . . .	12
3.5	Sizing of $M_{2a}$ - $M_{2b}$ . . . . .	13
3.6	Sizing of $M_{3a}$ - $M_{3b}$ and $M_{4a}$ - $M_{4b}$ . . . . .	14
3.7	Sizing $M_{5a}$ - $M_{5b}$ . . . . .	15
3.8	Bias voltages $V_{b1}$ and $V_{b2}$ . . . . .	15
3.9	Summary . . . . .	16
3.9.1	Specifications . . . . .	16
3.9.2	Bias . . . . .	16
3.9.3	Transistor information . . . . .	16
<b>4</b>	<b>OTA Characteristics</b>	<b>18</b>
4.1	Open-loop gain . . . . .	18
4.2	Input-referred noise . . . . .	19
4.3	Input-referred offset . . . . .	20
4.4	Current and power consumption . . . . .	21
<b>5</b>	<b>Simulation results from ngspice</b>	<b>23</b>
5.1	Operating point . . . . .	23
5.2	Large-signal differential transfer characteristic . . . . .	25
5.3	Open-loop gain . . . . .	26
5.4	Input-referred noise . . . . .	26
5.5	Input common-mode voltage range . . . . .	29
5.6	Step-response . . . . .	29
5.6.1	Small-step . . . . .	30
5.6.2	Large step . . . . .	30
5.7	Power consumption . . . . .	31
<b>6</b>	<b>Conclusion</b>	<b>32</b>
	<b>References</b>	<b>33</b>

# 1 Introduction

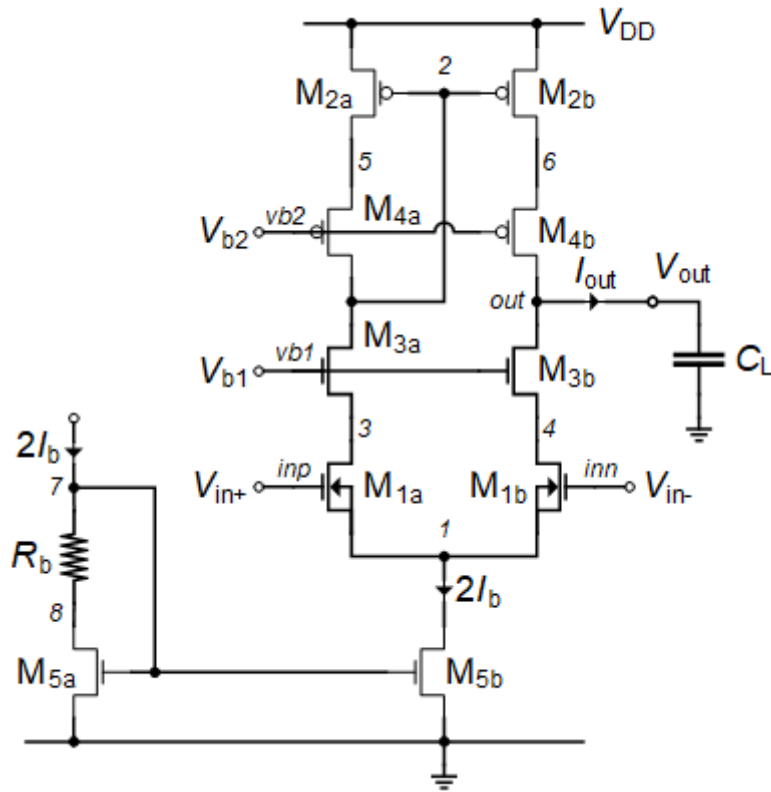


Figure 1.1: Schematic of the telescopic differential OTA.

**i** Note

Note that all nMOS transistors in Figure 1.1 have an odd number and all the pMOS transistors an even number which explains the numbering process.

This notebook presents the analysis, design and simulation of the telescopic cascode OTA which schematic is presented in Figure 1.1 [1]. The design phase is using the sEKV model and the inversion coefficient approach [2], [3], [4]. The telescopic OTA is similar to the simple OTA except that four cascode transistors, namely  $M_{3a}$ - $M_{3b}$  and  $M_{4a}$ - $M_{4b}$ , have been added to decrease the output conductance and hence increase the DC gain. The  $GBW$  and hence the power consumption however remain almost unchanged.

Because of the stacked transistors, this OTA is a bit tricky to design particularly at low-voltage and presents a reduced output voltage swing. In order to save some voltage, we have put  $M_{1a}$ - $M_{1b}$  in a separate well. This makes  $V_{SB1a} = V_{SB1b} = 0$  and reduces  $V_{GS1a}$  and  $V_{GS1b}$  to a minimum. When designing the circuit, we particularly need to be careful when sizing the cascode transistors in weak inversion avoiding taking minimum length which would degrade their output conductance and hence the DC gain. This is explained in more details below.

As suggested in [1], we also have added the resistance  $R_b$  that will be sized in order for  $M_{5a}$  and  $M_{5b}$  to have about the same  $V_{DS}$  voltage. This makes sure that the current through  $M_{5a}$  and  $M_{5b}$  are about equal, despite the effect of the output conductance.

We will start with a detailed analysis of the OTA which will allow to derive all the design equations that will be used in the design phase. The OTA is then designed for a given set of specifications for a generic 180 nm bulk CMOS technology. The design is then validated by simulations with ngspice [5] using the EKV 2.6 compact model [6] [7] [8] with parameters corresponding to a generic 180 nm bulk CMOS technology [9] [10].

We now start with the small-signal analysis.

## 2 Analysis

### 2.1 Small-signal analysis

We start with the small-signal analysis. The small-signal schematic of the telescopic OTA is shown in Figure 2.1. The analysis of the telescopic OTA is similar to the simple OTA, except that there are now additional nodes due to the cascode transistors.

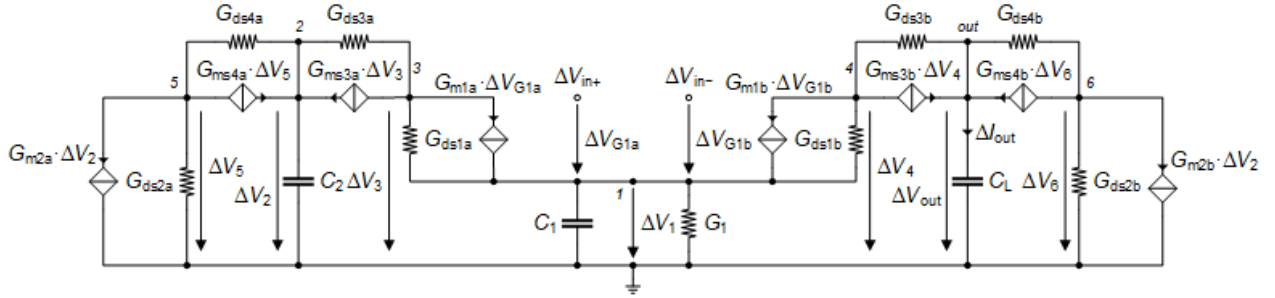


Figure 2.1: Small-signal schematic of the telescopic OTA.

For a differential input voltage, assuming a perfect matching between the transistors in the left and right current branches, the common-source node 1 of the differential pair  $M_{1a}$ - $M_{1b}$  remains zero and the small-signal schematic of Figure 2.1 simplifies to the schematic shown in Figure 2.2.

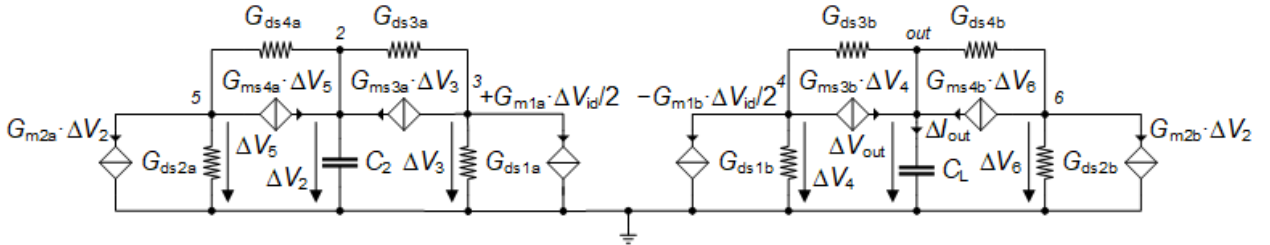


Figure 2.2: Simplified small-signal schematic of the telescopic OTA.

In a 1<sup>st</sup>-order analysis, we can neglect the capacitances at the low impedance cascode nodes 3, 4, 5 and 6 and only account for the capacitances at high impedance nodes 2 and out. The circuit becomes similar to that of the simple OTA, with the dominant pole  $\omega_0$  at the output node (out) and the non-dominant pole  $\omega_p$  at the current mirror node 2. The transfer function also has a pole-zero doublet. Its transfer function is then given by

$$A_{dm}(s) \triangleq \frac{\Delta V_{out}}{\Delta V_{in}} \cong A_{dc} \cdot \frac{1 + s/\omega_z}{(1 + s/\omega_0)(1 + s/\omega_p)} \cong \frac{A_{dc}}{1 + s/\omega_0} \cong \frac{\omega_u}{s}, \quad (2.1)$$

where

$$A_{dc} \cong \frac{G_{m1}}{G_o}, \quad (2.2)$$

$$G_o \cong \frac{G_{ds1} G_{ds3}}{G_{ms3}} + \frac{G_{ds2} G_{ds4}}{G_{ms4}}, \quad (2.3)$$

$$\omega_0 \cong \frac{G_o}{C_L}, \quad (2.4)$$

$$\omega_p \cong \frac{G_{m2}}{C_2}, \quad (2.5)$$

$$\omega_z = 2\omega_p, \quad (2.6)$$

$$\omega_u = A_{dc} \cdot \omega_0 \cong \frac{G_{m1}}{C_L}. \quad (2.7)$$

We now analyze the OTA noise in the next section.

## 2.2 Noise Analysis

At low-frequency the noise of the cascode transistors  $M_{3a}$ - $M_{3b}$  and  $M_{4a}$ - $M_{4b}$  can be neglected and the noise analysis is then identical to that of the simple OTA. The PSD of the output noise current is given by

$$S_{nout} \cong 2(S_{I_{n1}} + S_{I_{n2}}) \quad (2.8)$$

which can be expressed in terms of the output noise conductance as

$$S_{nout} = 4kT \cdot G_{nout}, \quad (2.9)$$

where

$$G_{nout} \cong 2(G_{n1} + G_{n2}), \quad (2.10)$$

with

$$G_{ni} = \gamma_{ni} \cdot G_{mi} + G_{mi}^2 \cdot \frac{\rho_i}{W_i L_i f} \quad \text{for } i = 1, 2. \quad (2.11)$$

The input-referred noise resistance is then given by

$$R_{nin} \triangleq \frac{G_{nout}}{G_{m1}^2} = \frac{2(G_{n1} + G_{n2})}{G_{m1}^2} = \frac{2G_{n1}}{G_{m1}^2} \cdot \left(1 + \frac{G_{n2}}{G_{n1}}\right) \quad (2.12)$$

which we rewrite as

$$R_{nin} = \frac{2G_{n1}}{G_{m1}^2} \cdot (1 + \eta) \quad (2.13)$$

with

$$\eta = \frac{G_{n2}}{G_{n1}}. \quad (2.14)$$

$\eta$  represents the contribution of the current mirror referred to the input and normalized to the contribution of the differential pair. Of course during the design phase we will try to minimize  $\eta$ .

### 2.2.1 Input-referred thermal noise

The input-referred thermal noise resistance is given by

$$R_{nth} = \frac{2\gamma_{n1}}{G_{m1}} \cdot (1 + \eta_{th}), \quad (2.15)$$

where

$$\eta_{th} = \frac{\gamma_{n2}}{\gamma_{n1}} \cdot \frac{G_{m2}}{G_{m1}} \quad (2.16)$$

represents the contribution to the input-referred thermal noise of the current mirror  $M_{2a}$ - $M_{2b}$  relative to that of the differential pair  $M_{1a}$ - $M_{1b}$ . In case  $G_{m1} \gg G_{m2}$  then  $\eta_{th} \ll 1$  and the thermal noise is dominated by the input differential pair. Eqn. (2.16) can then be simplified to

$$R_{nth} \cong \frac{2\gamma_{n1}}{G_{m1}}. \quad (2.17)$$

The OTA thermal noise excess factor is then given by

$$\gamma_{ota} \triangleq G_m \cdot R_{nth} \quad (2.18)$$

with  $G_m = G_{m1}$  is the OTA equivalent transconductance. The OTA thermal noise excess factor then writes

$$\gamma_{ota} = 2\gamma_{n1} \cdot (1 + \eta_{th}). \quad (2.19)$$

In the case  $G_{m1} \gg G_{m2}$  then  $\eta_{th} \ll 1$  and the noise is dominated by the input differential pair  $M_{1a}$ - $M_{1b}$ . The OTA thermal noise excess factor can then be simplified as

$$\gamma_{ota} \cong 2\gamma_{n1}. \quad (2.20)$$

### 2.2.2 Input-referred flicker noise

The input-referred flicker noise is given by

$$R_{nfl} = \frac{2}{f} \left[ \frac{\rho_n}{W_1 L_1} + \left( \frac{G_{m2}}{G_{m1}} \right)^2 \frac{\rho_p}{W_2 L_2} \right] \quad (2.21)$$

which can be rewritten as

$$R_{nfl} = \frac{2\rho_n}{W_1 L_1 f} \cdot (1 + \eta_{fl}) \quad (2.22)$$

where

$$\eta_{fl} = \frac{\rho_p}{\rho_n} \left( \frac{G_{m2}}{G_{m1}} \right)^2 \frac{W_1 L_1}{W_2 L_2} \quad (2.23)$$

represents the contribution to the input-referred flicker noise of the current mirror  $M_{2a}$ - $M_{2b}$  relative to that of the differential pair  $M_{1a}$ - $M_{1b}$ . If  $M_{1a}$ - $M_{1b}$  and  $M_{2a}$ - $M_{2b}$  have about the same gate area, then  $\eta_{fl}$  can be made small by making  $G_{m1} \gg G_{m2}$ .

The corner frequency is the frequency at which the flicker noise becomes equal to the thermal noise

$$R_{nfl}(f = f_k) = R_{nth} \quad (2.24)$$

which is given by

$$f_k = \frac{1}{R_{nth}} \cdot \frac{2\rho_n}{W_1 L_1} \cdot (1 + \eta_{fl}) = \frac{G_{m1} \rho_n}{\gamma_{n1} W_1 L_1} \cdot \frac{1 + \eta_{fl}}{1 + \eta_{th}}. \quad (2.25)$$

The transconductance  $G_{m1}$  is set by the constraints either on thermal noise or on bandwidth (GBW product). The corner frequency  $f_k$  can be reduced by increasing  $W_1 L_1$  and  $W_2 L_2$  at the same time to conserve the same  $\eta_{fl}$  factor. Assuming that  $G_{m2}/G_{m1} \ll 1$ , as required by the constraints on minimizing the contribution of the current mirror to the input-referred offset and thermal noise, then  $\eta_{th} \ll 1$  and  $\eta_{fl} \ll 1$  and the corner frequency  $f_k$  is then mainly set by the differential pair transconductance and gate transistor area

$$f_k \cong \frac{G_{m1} \rho_n}{\gamma_{n1} W_1 L_1}. \quad (2.26)$$

## 2.3 Input-referred offset voltage

The offset analysis is identical to that of the simple OTA because the contribution of the mismatch of the cascode transistors can be neglected. The random offset current is then mainly due to the mismatch between  $M_{1a}$  and  $M_{1b}$  and between  $M_{2a}$  and  $M_{2b}$ . The variance of the output offset current is then given by

$$\sigma_{I_{os}}^2 \cong \sigma_{\Delta I_{D1}}^2 + \sigma_{\Delta I_{D2}}^2 = I_b^2 \cdot \left( \sigma_{\frac{\Delta I_{D1}}{I_{D1}}}^2 + \sigma_{\frac{\Delta I_{D2}}{I_{D2}}}^2 \right), \quad (2.27)$$

with

$$\sigma_{\frac{\Delta I_{Di}}{I_{Di}}}^2 = \sigma_{\beta_i}^2 + \left( \frac{G_{mi}}{I_b} \right)^2 \sigma_{V_{Ti}}^2 \quad \text{for } i = 1, 2, \quad (2.28)$$

where

$$\sigma_{\beta_i}^2 = \frac{A_\beta^2}{W_i L_i} \quad \text{for } i = 1, 2 \quad (2.29)$$

is the  $\beta$ -mismatch and

$$\sigma_{V_{Ti}}^2 = \frac{A_{V_T}^2}{W_i L_i} \quad (2.30)$$

is the  $V_T$ -mismatch.

The variance of the output offset current then becomes

$$\sigma_{I_{os}}^2 = I_b^2 \cdot (\sigma_{\beta_1}^2 + \sigma_{\beta_2}^2) + G_{m1}^2 \cdot \sigma_{V_{T1}}^2 + G_{m2}^2 \cdot \sigma_{V_{T2}}^2. \quad (2.31)$$

The variance of the input-referred offset voltage is obtained by dividing the variance of the output offset current by  $G_{m1}^2$  resulting in

$$\sigma_{V_{os}}^2 = \left( \frac{I_b}{G_{m1}} \right)^2 (\sigma_{\beta_1}^2 + \sigma_{\beta_2}^2) + \sigma_{V_{T1}}^2 + \left( \frac{G_{m2}}{G_{m1}} \right)^2 \sigma_{V_{T2}}^2 \quad (2.32)$$

which can be written as

$$\sigma_{V_{os}}^2 = \sigma_{V_{T1}}^2 \cdot (1 + \xi_{V_T}) + \left( \frac{I_b}{G_{m1}} \right)^2 \cdot \sigma_{\beta_1}^2 \cdot (1 + \xi_\beta), \quad (2.33)$$

where  $\xi_{V_T}$  represents the  $V_T$ -mismatch contribution to the input-referred offset of the current mirror relative to that of the differential pair

$$\xi_{V_T} = \left( \frac{G_{m2}}{G_{m1}} \right)^2 \cdot \frac{\sigma_{V_{T2}}^2}{\sigma_{V_{T1}}^2} \quad (2.34)$$

and  $\xi_\beta$  represents the  $\beta$ -mismatch contributions to the input-referred offset of the current mirror relative to that of the differential pair

$$\xi_\beta = \frac{\sigma_{\beta_2}^2}{\sigma_{\beta_1}^2} \quad (2.35)$$

with

$$\sigma_{V_{T1}} = \frac{A_{V_{Tn}}^2}{W_1 L_1}, \quad (2.36)$$

$$\sigma_{V_{T2}} = \frac{A_{V_{Tp}}^2}{W_2 L_2} \quad (2.37)$$

and

$$\sigma_{\beta_1}^2 = \frac{A_{\beta_n}^2}{W_1 L_1}, \quad (2.38)$$

$$\sigma_{\beta_2}^2 = \frac{A_{\beta_p}^2}{W_2 L_2}. \quad (2.39)$$



Replacing in (2.34) and (2.35) results in

$$\xi_{V_T} = \left( \frac{G_{m2}}{G_{m1}} \right)^2 \cdot \left( \frac{A_{V_{Tp}}}{A_{V_{Tp}}} \right)^2 \cdot \frac{W_1 L_1}{W_2 L_2} \quad (2.40)$$

and

$$\xi_\beta = \left( \frac{A_{\beta_p}}{A_{\beta_n}} \right)^2 \cdot \frac{W_1 L_1}{W_2 L_2}. \quad (2.41)$$

Assuming that the  $V_T$ -mismatch parameters  $A_{V_{Tn}}$  and  $A_{V_{Tp}}$  and the area  $W_1 L_1$  and  $W_2 L_2$  are of the same order of magnitude, the contribution of the current mirror  $M_{2a}$ - $M_{2b}$  to the  $V_T$ -mismatch represented by the  $\xi_{V_T}$  parameter can be made small by choosing  $G_{m1} \gg G_{m2}$ . If this does not suffice, we can increase the area of  $M_{2a}$ - $M_{2b}$  keeping its  $W/L$  ratio.

The contribution of  $M_{2a}$ - $M_{2b}$  to the  $\beta$ -mismatch, represented by the  $\xi_\beta$  factor, is not weighted by the  $G_m$  ratio. Assuming that the  $\beta$ -mismatch parameters  $A_{\beta_n}$  and  $A_{\beta_p}$  are of the same order of magnitude,  $\xi_\beta$  can be reduced by increasing the area of  $M_{2a}$ - $M_{2b}$  keeping its  $W/L$  ratio.

## 3 Design

### 3.1 Specifications

The OTA specifications are given in Table 3.1.

#### **i** Note

The specifications given in Table 3.1 are simplified specifications. They are mainly targeting the achievement of a certain gain-bandwidth product  $GBW$  and DC gain at lowest current consumption. The  $GBW$  sets the differential pair transconductance while the DC gain sets the output conductance. There is an additional specification on the random input-referred offset voltage which, if not met, might eventually require to increase the transistors area. There are no specifications on thermal noise since the transconductance is set by the  $GBW$ . There are no specifications on the flicker noise but if the corner frequency was set lower this would require to increase the transistors area. There are also no specifications on the slew-rate, which might be small because of the low-power objective. Finally, there are many more specifications such as CMRR, PSRR, input common-mode voltage range, output-voltage swing, etc... that are not discussed in this example.

Table 3.1: OTA specifications.

Specification	Symbol	Value	Unit
Minimum DC gain	$A_{dc}$	100	$dB$
Minimum gain-bandwidth product	$GBW$	1	$MHz$
Load capacitance	$C_L$	1	$pF$
Maximum input-referred random offset voltage	$V_{os}$	10	$mV$
Phase margin	$PM$	60	$^\circ$
Corner frequency	$f_k$	100	$kHz$

### 3.2 Process

We will design the cascode gain stage for a generic 180nm bulk CMOS process. The physical parameters are given in Table 3.2, the global process parameters in Table 3.3 and finally the MOSFET parameters in Table 3.4.

Table 3.2: Physical parameters

Parameter	Value	Unit
$T$	300	$K$
$U_T$	25.875	$mV$

Table 3.3: Global process parameters

Parameter	Value	Unit
$V_{DD}$	1.8	$V$
$C_{ox}$	8.443	$\frac{fF}{\mu m^2}$
$W_{min}$	200	$nm$
$L_{min}$	180	$nm$

Table 3.4: Transistor process parameters

Parameter	NMOS	PMOS	Unit
sEKV parameters			
$n$	1.27	1.31	-
$I_{spec\Box}$	715	715	$nA$
$V_{T0}$	0.455	0.445	$V$
$L_{sat}$	26	36	$nm$
$\lambda$	20	20	$\frac{V}{\mu m}$
Overlap capacitances parameters			
$C_{GDo}$	0.366	0.329	$\frac{fF}{\mu m}$
$C_{GSo}$	0.366	0.329	$\frac{fF}{\mu m}$
$C_{GBo}$	0	0	$\frac{fF}{\mu m}$
Junction capacitances parameters			
$C_J$	1	1.121	$\frac{fF}{\mu m^2}$
$C_{JSW}$	0.2	0.248	$\frac{fF}{\mu m}$
Flicker noise parameters			
$K_F$	8.1e-24	8.1e-24	$J$
$AF$	1	1	-
$\rho$	0.05794	0.4828	$\frac{V \cdot m^2}{A \cdot s}$
Matching parameters			
$A_{VT}$	5	5	$mV \cdot \mu m$
$A_\beta$	1	1	$\% \cdot \mu m$
Source and drain sheet resistance parameter			
$R_{sh}$	600	2386	$\frac{\Omega}{\mu m}$
Width and length parameters			
$\Delta W$	39	54	$nm$
$\Delta L$	-76	-72	$nm$

### 3.3 Design procedure

#### ! Important

For this process, the transistor dimensions are rounded to 10nm. We also will ignore the length and width reduction parameters  $DL$  and  $DW$ . The main reason is that most of the transistor length and width are sufficiently large that ignoring these parameters has little impact.

### 3.4 Sizing of M<sub>1a</sub>-M<sub>1b</sub>

M<sub>1a</sub>-M<sub>1b</sub> are biased in weak inversion in order to minimize the input-referred offset. They are sized according to the specification on the GBW and the load capacitance and the required slew-rate.

Recalling that

$$GBW = \frac{G_{m1}}{2\pi C_{out}}, \quad (3.1)$$

where  $C_{out}$  is the total output capacitance which includes the parasitic capacitance and the load capacitance  $C_L$ . Since we do not yet know the sizes of M<sub>1a</sub> and M<sub>2b</sub>, we cannot estimate the total output capacitance. We will start assuming  $C_{out} = C_L$ .

$G_{m1}$  is the gate transconductance of M<sub>1a</sub> and M<sub>1b</sub> which in deep weak inversion is given by

$$G_{m1} = \frac{I_b}{nU_T}. \quad (3.2)$$

The bias current  $I_b$  is the current flowing in each transistor M<sub>1a</sub> and M<sub>1b</sub> when the input differential voltage is zero. The bias current provided by M<sub>3b</sub> is therefore  $2I_b$ . The bias current must satisfy the following inequality

$$I_b \geq 2\pi n_{0n} U_T C_L GBW_{min}. \quad (3.3)$$

which for the given specifications gives  $I_{b,min} = 207 \text{ nA}$ . The corresponding slew-rate is given by  $SR_{min} = 207 \text{ mV}/\mu\text{s}$ , which we will consider as sufficient.

#### ! Important

If the slew-rate is not sufficient, the bias current  $I_b$  should be increased resulting in a higher current and power consumption. Other options include the use of a class AB OTA [11] or a dynamic/adaptive biasing OTA [12].

Because the cascode transistors M<sub>3b</sub> and M<sub>4b</sub> will be rather large, they will add a significant parasitic capacitance to the output node that add to the load capacitance  $C_L$ . We therefore need to take some margin to account for these additional parasitic capacitances at the output by setting the bias current to  $I_b = 250 \text{ nA}$  and the inversion coefficient to  $IC_1 = 0.1$ . The transconductance  $G_{m1}$  of M<sub>1a</sub>-M<sub>1b</sub> can be calculated from the  $G_m/I_D$  function as  $G_{m1} = 6.962 \mu\text{A}/\text{V}$ . This leads to the following gain-bandwidth product  $GBW = 1.1 \text{ MHz}$ , which is slightly higher than the target specification offering some margin. Knowing the drain current  $I_D$  and the inversion coefficient  $IC$ , we can calculate  $I_{spec1} = 2.5 \mu\text{A}$  and  $W_1/L_1 = 3.5$ . The degree of freedom left ( $W_1$  or  $L_1$ ) can be determined from the specification on the maximum flicker noise corner frequency

$$f_k = \frac{\rho_n G_{m1}}{W_1 L_1 \gamma_{n1}} \cdot \frac{1 + \eta_{fl}}{1 + \eta_{th}}. \quad (3.4)$$

We will assume that  $\eta_{th} \ll 1$  and set  $\eta_{fl} = 1$ . We can then deduce the gate area of M<sub>1a</sub>-M<sub>1b</sub> as

$$W_1 L_1 = \frac{\rho_n G_{m1}}{f_k \gamma_{n1}} \cdot \frac{1 + \eta_{fl}}{1 + \eta_{th}}. \quad (3.5)$$

This leads to  $W_1 L_1 = 12.34 \mu\text{m}^2$  and  $W_1 = 6.57 \mu\text{m}$  and  $L_1 = 1.88 \mu\text{m}$ .

We have finalized the sizing of the differential pair M<sub>1a</sub>-M<sub>1b</sub>. We can now size the pMOS current mirror M<sub>2a</sub>-M<sub>2b</sub>.

### 3.5 Sizing of M<sub>2a</sub>-M<sub>2b</sub>

Because of the transistors stacking, the design of the telescopic OTA becomes tricky at low voltage. The current mirror M<sub>2a</sub>-M<sub>2b</sub> should be biased as much in strong inversion as the voltage constraint allows for. We choose to set the quiescent output voltage to  $V_{outq} = V_{DD}/2 = 0.9 \text{ V}$ . The  $V_{SG2}$  voltage will set the open-loop quiescent output voltage and is therefore equal to  $V_{SG2} = V_{DD} - V_{outq} = 900 \text{ mV}$ . This corresponds to an inversion coefficient equal to  $IC_2 = 40.1$  and a saturation voltage  $V_{SDsat2} = 343 \text{ mV}$ . Having set the inversion coefficient and bias current we can derive  $I_{spec2} = 6.24 \text{ nA}$  and  $W_2/L_2 = 0.036$ . Having  $IC$  and  $I_D$ , we can deduce  $G_{m2} = 1.080 \text{ } \mu\text{A/V}$ .

We will now have to make sure that the non-dominant pole  $f_p$  at node 2 is sufficiently higher than the gain-bandwidth product  $GBW$  to insure the desired phase margin. The non-dominant pole is given by

$$\omega_p = \frac{G_{m2}}{C_2}, \quad (3.6)$$

where  $C_2$  is given by

$$C_2 = 2(C_{GS2} + C_{GB2}) \quad (3.7)$$

Assuming M<sub>2a</sub>-M<sub>2b</sub> are biased in saturation, the gate-to-source capacitance  $C_{GS2}$  is given by

$$C_{GS2} \cong W_2 L_2 C_{ox} \cdot c_{gsi} + C_{GSop} \cdot W_2, \quad (3.8)$$

where  $C_{GSop}$  and  $C_{GSfp}$  are the gate-to-source overlap and fringing capacitances per unit width for pMOS transistors.  $c_{gsi}$  is the intrinsic gate-to-source capacitance normalized to the total gate area  $W L C_{ox}$ , which is typically equal to 2/3 in strong inversion and is proportionnal to  $IC$  in weak inversion.

The gate-to-bulk capacitance  $C_{GB2}$  is given by

$$C_{GB2} \cong W_2 L_2 C_{ox} \cdot c_{gbi} + C_{GBop} \cdot W_2, \quad (3.9)$$

where  $C_{GBop}$  is the gate-to-bulk overlap capacitance per unit width and  $c_{gbi}$  is the gate-to-bulk intrinsic capacitance normalized to the total gate area  $W L C_{ox}$  and given by

$$c_{gbi} = \frac{n-1}{n} \cdot c_{gsi}. \quad (3.10)$$

The capacitance at node 2 scales with  $W_2$  and  $L_2$  according to

$$C_2 = C_{WL} \cdot W_2 L_2 + C_W \cdot W_2, \quad (3.11)$$

with

$$C_{WL} = 2 C_{ox} \cdot (c_{gsi} + c_{gbi}), \quad (3.12)$$

$$C_W = 2(C_{GSop} + C_{GBop}). \quad (3.13)$$

Since the  $W/L$  has already been set by the transconductance and the current, we can derive  $W_2$  and  $L_2$  for achieving a given capacitance  $C_2$  according to

$$W_2 = \frac{-C_W \cdot W_2/L_2 + \sqrt{W_2/L_2 \cdot \sqrt{4 C_2 C_{WL} + C_W^2 \cdot W_2/L_2}}}{2 C_{WL}}, \quad (3.14)$$

$$L_2 = \frac{W_2}{W_2/L_2}. \quad (3.15)$$

Setting the non-dominant pole  $f_p$  to 10 times the  $GBW$ , we get  $C_2 = 16 \text{ fF}$ ,  $L_2 = 6.00 \text{ } \mu\text{m}$  and  $W_2 = 220 \text{ nm}$ .

We can check the contributions of  $M_{2a}$ - $M_{2b}$  to the thermal and flicker noise  $\eta_{th} = 0.199$  and  $\eta_{fl} = 1.472$ . The resulting corner frequency is then given by  $f_k = 103.032 \text{ kHz}$  which is higher than the specification  $f_k = 100 \text{ kHz}$  because of the larger  $\eta_{fl}$  compared to the initial value. We can slightly increase the gate area  $W_1 L_1$  of  $M_{1a}$ - $M_{1b}$ .

With  $W_1 L_1 = 14.307 \text{ } \mu\text{m}^2$ , the resulting corner frequency is  $f_k = 97.555 \text{ kHz}$ , which is now lower than the specification  $f_k = 100 \text{ kHz}$ .

The new values of  $W_1$  and  $L_1$  are given by  $W_1 = 7.07 \text{ } \mu\text{m}$  and  $L_1 = 2.02 \text{ } \mu\text{m}$ .

### 3.6 Sizing of $M_{3a}$ - $M_{3b}$ and $M_{4a}$ - $M_{4b}$

The cascode transistors are sized according to the desired DC gain given by

$$A_{dc} = \frac{G_{m1}}{G_o} \quad (3.16)$$

where  $G_o$  is the conductance at the output node given by

$$G_o \cong G_{o1} + G_{o2} \quad (3.17)$$

with

$$G_{o1} = \frac{G_{ds1b} \cdot G_{ds3b}}{G_{ms3b}}, \quad (3.18)$$

$$G_{o2} = \frac{G_{ds2b} \cdot G_{ds4b}}{G_{ms4b}}. \quad (3.19)$$

To have some margin on the DC gain we will design for a minimum DC gain higher than the specification given by  $A_{dc} = 100 \text{ dB}$  or  $A_{dc} = 1.000\text{e}+05$ . We can then deduce the output conductance as  $G_o = G_{m1}/A_{dc} = 0.070 \text{ nA/V}$ . We will split the output conductance  $G_o$  equally between the nMOS and pMOS cascodes.

To minimize the saturation voltage and maximize the current efficiency, the cascode transistors  $M_{3a}$ - $M_{3b}$  and  $M_{4a}$ - $M_{4b}$  are biased in weak inversion. We choose their inversion coefficient as  $IC_3 = IC_4 = 0.1$ , which gives a saturation voltage  $V_{DSsat4} = 105 \text{ mV}$ . Having set the  $IC$  and knowing the bias current, we can deduce  $I_{spec3} = 2.5 \text{ } \mu\text{A}$  and  $W_3/L_3 = 3.496$  for  $M_{3a}$ - $M_{3b}$  and  $I_{spec4} = 2.5 \text{ } \mu\text{A}$  and  $W_4/L_4 = 14.440$  for  $M_{4a}$ - $M_{4b}$ . We can now calculate the  $G_{ms}$  that is needed for the calculation of the output conductances  $G_{ms3} = 8.851 \text{ } \mu\text{A/V}$  and  $G_{ms4} = 8.851 \text{ } \mu\text{A/V}$ . Having already the length of  $M_{2a}$ - $M_{2b}$ , we can estimate its output conductance  $G_{ds2}$  as  $G_{ds2} = 2.083 \text{ nA/V}$ . We can then deduce the output conductance  $G_{ds4}$  of  $M_{4a}$ - $M_{4b}$  as  $G_{ds4} = 147.9 \text{ nA/V}$ , which corresponds to a cascode gain  $G_{ms4}/G_{ds4} = 59.9$ . We can deduce the length of  $M_{4a}$ - $M_{4b}$  from  $G_{ds4}$  as  $L_4 = 80 \text{ nm}$ , which is smaller than  $L_{min}$ .

In order not to degrade the output conductance, we choose  $L_4$  to be 3 times  $L_{min}$  resulting in  $L_4 = 540 \text{ nm}$ , which gives a width equal to  $W_4 = 7.80 \text{ } \mu\text{m}$ . We can re-estimate the output conductances  $G_{o2} = 0.005 \text{ nA/V}$  giving  $G_{o1} = 0.064 \text{ nA/V}$ .

Since we already know the length  $L_1 = 2.02 \text{ } \mu\text{m}$  and the current  $I_b = 250 \text{ nA}$  for  $M_{1a}$ - $M_{1b}$ , we can estimate its output conductance  $G_{ds1} = 6.188 \text{ nA/V}$ . The output conductance of  $M_{3a}$ - $M_{3b}$  is then given by  $G_{ds3} = 91.784 \text{ nA/V}$  from which we can deduce its length  $L_3 = 136 \text{ nm}$  and its width  $W_3 = 0.48 \text{ } \mu\text{m}$ .

In order to maximize the DC gain we will choose  $L_3 = 540 \text{ nm}$ . Keeping the same  $W/L$  results in  $W_3 = 1.89 \text{ } \mu\text{m}$ . The DC gain is now  $A_{dc} = 110.152 \text{ dB}$ .

### 3.7 Sizing M<sub>5a</sub>-M<sub>5b</sub>

The sizing of M<sub>5a</sub>-M<sub>5b</sub> is conditioned by the minimum input common-mode voltage keeping M<sub>5a</sub>-M<sub>5b</sub> in saturation

$$V_{ic,min} = V_{GS1} + V_{DSsat5} \quad (3.20)$$

The gate-to-source voltage  $V_{GS1}$  is given by

$$V_{GS1} = V_{T0n} + (n_{0n} - 1) V_{S1} + n_{0n} U_T (v_p - v_s) \quad (3.21)$$

Since M<sub>1a</sub>-M<sub>1b</sub> are in a separate well  $V_{SB1} = 0$ . Additionally in weak inversion we can consider  $v_p - v_s \cong 0$ .  $V_{GS1}$  can therefore be approximated by  $V_{GS1} \cong V_{T0n}$ . This gives  $V_{GS1} = 455 \text{ mV}$ , which for  $V_{ic} = V_{DD}/2 = 900 \text{ mV}$  leaves  $V_{DS3} = 445 \text{ mV}$ . If we set the saturation voltage of M<sub>5a</sub>-M<sub>5b</sub> to  $V_{DSsat5} = 300 \text{ mV}$ , this corresponds to an inversion coefficient  $IC_5 = 29.6$ . Having the  $IC$  and the current we can derive  $I_{spec5} = 17 \text{ nA}$  and  $W_5/L_5 = 0.024$ . Since  $W_5/L_5$  is small, we need to set  $W_5$  to  $W_5 = W_{min} = 200 \text{ nm}$  resulting in  $L_5 = 8.47 \text{ }\mu\text{m}$ . Note that the minimum input common-mode voltage is then given by  $V_{ic,min} = 755 \text{ mV}$ .

We still need to calculate the required bias voltages  $V_{b1}$  for M<sub>3a</sub>-M<sub>3b</sub> and  $V_{b2}$  for M<sub>4a</sub>-M<sub>4b</sub> which is done in the next section.

### 3.8 Bias voltages $V_{b1}$ and $V_{b2}$

We start calculating the maximum bias voltage  $V_{b2,max}$  still keeping M<sub>2a</sub>-M<sub>2b</sub> in saturation

$$V_{b2,max} = V_{DD} - V_{SG4} - V_{SDsat2} \quad (3.22)$$

with  $V_{SG4} = 445 \text{ mV}$  and  $V_{SDsat2} = 343 \text{ mV}$ , we get  $V_{b2,max} = 1.012 \text{ V}$ .

We also want to make sure that the  $V_{SD}$  voltage across M<sub>4a</sub>-M<sub>4b</sub> is large enough not to degrade its output conductance

$$V_{b2,min} = V_{SD4} - V_{SG4} + V_{DD} - V_{SG2}. \quad (3.23)$$

Setting the source-to-drain voltage of M<sub>4a</sub>-M<sub>4b</sub> to  $V_{SD4} = 200 \text{ mV}$ , with  $V_{SG4} = 445 \text{ mV}$  and  $V_{SG2} = 900 \text{ mV}$ , we get  $V_{b2,min} = 0.655 \text{ V}$ .

Similarly, we can calculate the maximum bias voltage  $V_{b1,max}$  allocating enough  $V_{DS}$  voltage for M<sub>3a</sub>-M<sub>3b</sub> not to degrade its output conductance. This leads to

$$V_{b1,max} = V_{GS3} - V_{DS3} - V_{SG2} + V_{DD}. \quad (3.24)$$

Allocating  $V_{DS3} = 200 \text{ mV}$ , with  $V_{GS3} = 455 \text{ mV}$  and  $V_{SG2} = 900 \text{ mV}$ , we get  $V_{b1,max} = 1.155 \text{ V}$ .

We also want to make sure that the  $V_{DS}$  voltage of M<sub>1a</sub>-M<sub>1b</sub> is large enough not to degrade its output conductance. This sets a minimum value for  $V_{b1}$  given by

$$V_{b1,min} = V_{GS3} + V_{DS1} - V_{GS1} + V_{ic}. \quad (3.25)$$

For  $V_{ic} = 0.9 \text{ V}$  and  $V_{DS1} = 200 \text{ mV}$ , with  $V_{GS1} = 455 \text{ mV}$ , we get  $V_{b1,min} = 1.100 \text{ V}$

#### **i** Note

Setting  $V_{b1}$  and  $V_{b2}$  is tricky and requires a bit of fine tuning. After checking by simulation, we finally choose  $V_{b1} = 1.200 \text{ V}$  and  $V_{b2} = 0.700 \text{ V}$ .

The design is now finalized. The transistor sizes and bias are summarized below.

## 3.9 Summary

### 3.9.1 Specifications

The specifications are recalled in Table 3.5.

Table 3.5: OTA specifications.

Specification	Symbol	Value	Unit
Minimum DC gain	$A_{dc}$	100	$dB$
Minimum gain-bandwidth product	$GBW$	1	$MHz$
Load capacitance	$C_L$	1	$pF$
Maximum input-referred random offset voltage	$V_{os}$	10	$mV$
Phase margin	$PM$	60	$^\circ$
Corner frequency	$f_k$	100	$kHz$

### 3.9.2 Bias

The bias information are summarized in Table 3.6.

Table 3.6: OTA bias.

Bias voltage or current	Symbol	Value	Unit
Supply voltage	$V_{DD}$	1.8	$V$
Bias current	$I_b$	250.0	$nA$
Cascode bias voltage	$V_{b1}$	1.2	$V$
Cascode bias voltage	$V_{b2}$	0.7	$V$

### 3.9.3 Transistor information

The transistor sizes and large-signal variables are summarized in Table 3.7, whereas Table 3.8 gives the small-signal and thermal noise parameters. An Excel table is generated with more information (e.g. all the parasitic capacitances).

Table 3.7: Transistor size and bias information.

Transistor	$W$ [ $\mu m$ ]	$L$ [ $\mu m$ ]	$I_D$ [ $nA$ ]	$I_{spec}$ [ $nA$ ]	$IC$	$V_G - V_{T0}$ [ $mV$ ]	$V_{DSsat}$ [ $mV$ ]
M1a	7.07	2.02	250	2503	0.1	-45	105
M1b	7.07	2.02	250	2503	0.1	-45	105
M2a	0.22	6.00	250	6	39.4	264	341
M2b	0.22	6.00	250	6	39.4	264	341
M3a	1.89	0.54	250	2503	0.1	-45	105
M3b	1.89	0.54	250	2503	0.1	-45	105
M4a	7.80	0.54	250	2501	0.1	-44	105
M4b	7.80	0.54	250	2501	0.1	-44	105
M5a	0.20	8.47	500	17	29.6	235	300
M5b	0.20	8.47	500	17	29.6	235	300



Table 3.8: Transistor small-signal and thermal noise parameters.

Transistor	$G_{spec} [\mu A/V]$	$G_{ms} [\mu A/V]$	$G_m [\mu A/V]$	$G_{ds} [nA/V]$	$\gamma_n$
M1a	96.716	8.852	6.962	6.188	0.653
M1b	96.716	8.852	6.962	6.188	0.653
M2a	0.245	1.422	1.089	2.083	0.839
M2b	0.245	1.422	1.089	2.083	0.839
M3a	96.716	8.852	6.962	23.148	0.653
M3b	96.716	8.852	6.962	23.148	0.653
M4a	96.650	8.851	6.777	23.148	0.671
M4b	96.650	8.851	6.777	23.148	0.671
M5a	0.652	3.240	2.548	2.952	0.812
M5b	0.652	3.240	2.548	2.952	0.812

## 4 OTA Characteristics

In this section, we check whether the specs are achieved.

### 4.1 Open-loop gain

We can calculate the various OTA features related to the open-loop transfer function, which are given in Table 4.1.

Table 4.1: OTA gain variables.

Symbol	Theoretical Value	Unit
$A_{dc}$	110.154	$dB$
$G_{m1}$	6.962	$\mu A/V$
$G_{ds1}$	6.188	$nA/V$
$G_{m2}$	1.089	$\mu A/V$
$G_{ds2}$	2.083	$nA/V$
$G_{ms3}$	8.852	$\mu A/V$
$G_{ds3}$	23.148	$nA/V$
$G_{ms4}$	8.851	$\mu A/V$
$G_{ds4}$	23.148	$nA/V$
$C_2$	15.784	$fF$
$f_0$	3.424	$Hz$
$GBW$	1.102	$MHz$
$f_p$	10.977	$MHz$
$f_z$	21.954	$MHz$

The gain-bandwidth product from the specifications is repeated here

$GBW = 1.000 \text{ MHz}$  (from spec).

The estimate value assuming that all the non-dominant poles are much higher than the  $GBW$  is given by

$GBW_{est} = 1.102 \text{ MHz}$  (estimation).

The  $GBW$  accounting for the effect of the additional non-dominant poles is given by

$GBW_{the} = 1.098 \text{ MHz}$  (theory).

We see that there is only a small difference between  $GBW_{est}$  and  $GBW_{the}$ , which confirms that the non-dominant poles are sufficiently far from  $GBW$  as stated in Table 4.1.

We can now plot the gain response Using the variables given in Table 4.1. It is shown in Figure 4.1.

From Figure 4.1, we see that the  $GBW$  is right on target and the DC gain is much larger than the specification.

We can now have a look at the input-referred noise PSD.

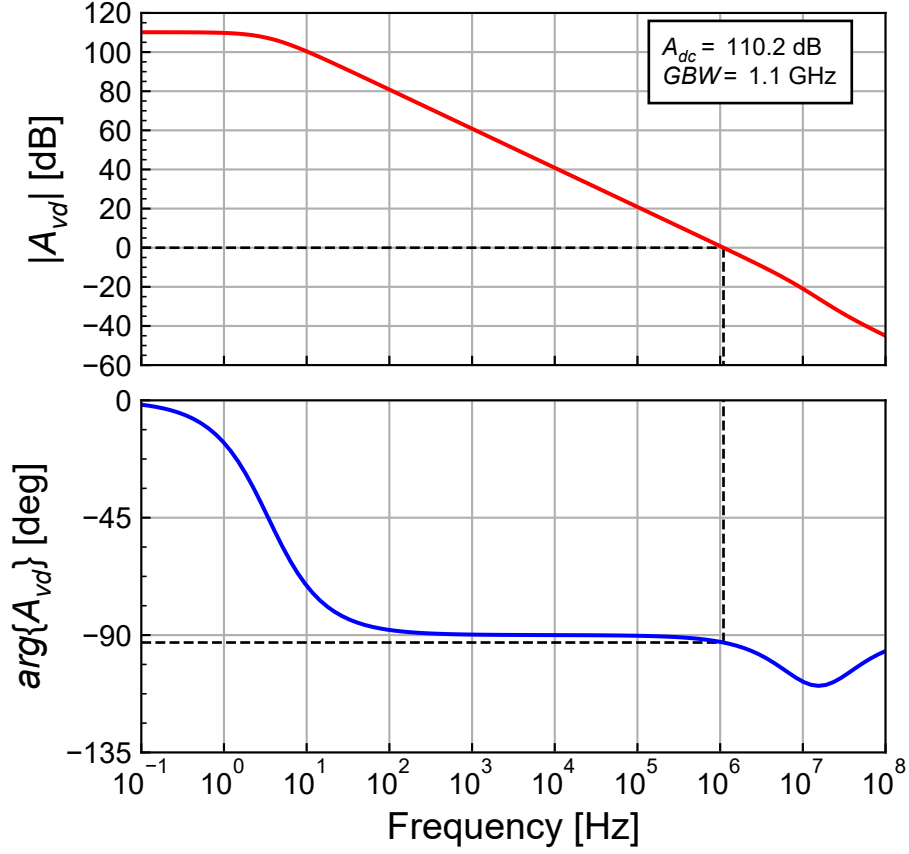


Figure 4.1: OTA theoretical transfer function.

## 4.2 Input-referred noise

We can compute all the parameters needed for the calculation of the OTA thermal noise excess factor and its input-referred thermal noise PSD and resistance. They are given in Table 4.2.

Table 4.2: OTA thermal noise parameters.

Symbol	Theoretical Value	Unit
$G_{m1}$	6.962	$\mu A/V$
$G_{m2}$	1.089	$\mu A/V$
$G_{m1}/G_{m2}$	6.395	-
$\gamma_{n1}$	0.653	-
$\gamma_{n2}$	0.839	-
$\eta_{th}$	0.201	-
$\gamma_{ota}$	1.569	-
$R_{nt}$	225.378	$k\Omega$
$\sqrt{S_{ninth}}$	61.092	$nV/\sqrt{Hz}$
$10 \cdot \log(S_{ninth})$	-144.280	$dBv/\sqrt{Hz}$

From Table 4.2, we see that the OTA thermal noise excess factor  $\gamma_{ota} = 1.569$  is only slightly larger than that of the differential pair  $2\gamma_{n1} = 1.307$ . This is due to the low value of  $\eta_{th} = 0.201$  indicating that the current mirror  $M_{2a}$ - $M_{2b}$  is contributing about half the contribution of the differential pair  $M_{1a}$ - $M_{1b}$ .

We can now compute all the parameters needed for the calculation of the input-referred flicker noise and the corner frequency. They are given in Table 4.3.

Table 4.3: OTA flicker noise parameters.

Symbol	Theoretical Value	Unit	Comment
$(G_{m1}/G_{m2})^2$	40.900	-	
$\rho_p/\rho_n$	8.333	-	
$\frac{W_1 \cdot L_1}{W_2 \cdot L_2}$	8.508	-	
$\eta_{fl}$	1.734	-	
$\sqrt{S_{nin,fl}(1\text{ Hz})}$	19.482	$\mu\text{V}/\sqrt{\text{Hz}}$	
$10 \cdot \log(S_{nin,fl}(1\text{ Hz}))$	-94.207	$\text{dBV}/\sqrt{\text{Hz}}$	
$(1 + \eta_{fl})/(1 + \eta_{th})$	2.277	-	
$f_k$	43.224	$\text{kHz}$	Differential pair only
$f_k$	98.406	$\text{kHz}$	

From Table 4.3, we see that  $\eta_{fl} = 1.734$ , which means that the contribution of the current mirror  $M_{2a}$ - $M_{2b}$  to the input-referred flicker noise is about the same as the differential pair  $M_{1a}$ - $M_{1b}$  despite the flicker of pMOS transistor is higher by a factor  $\rho_p/\rho_n = 8.333$  for the same gate area. We also see that the corner frequency is lower than the specification due to the fact that we have increased the length of  $M_{1a}$ - $M_{1b}$  for achieving the DC gain.

We can plot the input-referred noise which is shown in Figure 4.2.

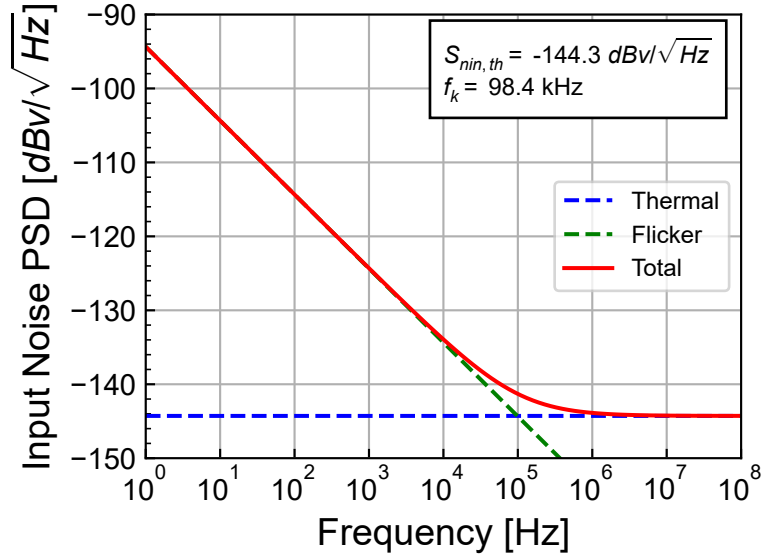


Figure 4.2: OTA theoretical input-referred noise PSD.

### 4.3 Input-referred offset

The variance of the input-referred offset voltage is given by (2.33), which is repeated below

$$\sigma_{V_{os}}^2 = \sigma_{V_T}^2 + \sigma_{\beta}^2, \quad (4.1)$$

where

$$\sigma_{V_T}^2 = \sigma_{V_{T1}}^2 \cdot (1 + \xi_{V_T}) \quad (4.2)$$

is the  $V_T$ -mismatch and

$$\sigma_\beta^2 = \left( \frac{I_b}{G_{m1}} \right)^2 \cdot \sigma_{\beta_1}^2 \cdot (1 + \xi_\beta) \quad (4.3)$$

is the  $\beta$ -mismatch with

$$\sigma_{V_{T1}} = \frac{A_{V_{Tn}}^2}{W_1 L_1} \quad (4.4)$$

and

$$\sigma_{\beta_1}^2 = \frac{A_{\beta_n}^2}{W_1 L_1}. \quad (4.5)$$

$\xi_{V_T}$  represents the  $V_T$ -mismatch contribution to the input-referred offset of the current mirror relative to that of the differential pair. It is given by (2.40) which is repeated below

$$\xi_{V_T} = \left( \frac{G_{m2}}{G_{m1}} \right)^2 \cdot \left( \frac{A_{V_{Tp}}}{A_{V_{Tp}}} \right)^2 \cdot \frac{W_1 L_1}{W_2 L_2}. \quad (4.6)$$

$\xi_\beta$  represents the  $\beta$ -mismatch contributions to the input-referred offset of the current mirror relative to that of the differential pair. It is given by (2.41) which is repeated below

$$\xi_\beta = \left( \frac{A_{\beta_p}}{A_{\beta_n}} \right)^2 \cdot \frac{W_1 L_1}{W_2 L_2}. \quad (4.7)$$

The parameter for calculating the standard deviation of the input-referred offset voltage are given in Table 4.4.

Table 4.4: OTA input-referred offset parameters.

Symbol	Theoretical Value	Unit
$\sigma_{VT1}$	1.323	$mV$
$\sigma_{VT2}$	4.352	$mV$
$\sigma_{\beta_1}$	0.265	%
$\sigma_{\beta_2}$	0.870	%
$\xi_{V_T}$	0.265	-
$\xi_\beta$	10.819	-
$\sigma_{V_T}^2$	2.214	$mV^2$
$\sigma_{V_T}$	1.488	$mV$
$\sigma_\beta^2$	0.107	$mV^2$
$\sigma_\beta$	0.327	$mV$
$\sigma_{V_{os}}$	1.523	$mV$

From Table 4.4, we see that the  $\beta$ -mismatch is negligible and that the input-referred offset voltage is dominated by the contribution of the  $V_T$ -mismatch from the differential pair.

## 4.4 Current and power consumption

The total current consumption, ignoring the current drawn by  $M_{5a}$ , is  $I_{tot} = 2I_b = 0.5 \mu A$ . Assuming the input differential pair  $M_{1a}$ - $M_{1b}$  is biased in deep weak inversion, the minimum bias current is directly related to the gain-bandwidth product  $GBW$  according to

$$I_{b,min} \cong nU_T \cdot C_L \cdot \omega_u = nU_T \cdot C_L \cdot 2\pi GBW = 207 nA.$$

The minimum total current consumption can then be estimated as  $I_{tot,min} \cong 2I_{b,min} = 413 \text{ nA}$ . The actual current consumption accounting for some margin taken on the  $GBW$  is therefore 21% higher than the minimum.

**i** Note

Note that the telescopic OTA is the differential OTA that has the minimum power consumption for similar gain-bandwidth product, DC gain and phase margin specifications. Of course it has the smallest input and output voltage swings.

The above design will now be checked against simulations.

## 5 Simulation results from ngspice

The theoretical results can be validated with the results obtained from simulations performed with ngspice. In order to run the simulations you need to have ngspice correctly installed. Please refer to the installation instructions.

### **i** Note

The simulations are performed with ngspice [5] using the EKV 2.6 compact model [6] [13] [2]. For ngspice, we use the original Verilog-A implementation of EKV 2.6 [8] modified by C. Enz to get the operating point informations and available on the Gitub va-models site provided by D. Warning at [7] [14]. The Verilog-A code was then compiled with OpenVAF [15] to generate the OSDI for running it with ngspice. The parameters correspond to a generic 180 nm bulk CMOS process [9].

### 5.1 Operating point

We first write the parameter file for this specific design for running the ngspice simulations. Before running the AC and NOISE simulations, we first need to check the quiescent voltages and currents and the operating points of all transistors by running a .OP simulation.

Table 5.1: OTA node voltages with the OTA in open-loop without offset correction.

Node	Voltage
vdd	1.800
vb1	1.200
vb2	0.700
inp	0.900
inn	0.900
out	0.905
ic	0.900
id	0.000
1	0.402
2	0.905
3	0.628
4	0.628
5	1.264
6	1.264
7	0.821
8	0.399

We can extract the OTA quiescent node voltages from the ngspice .ic file. They are presented in Table 5.1. We see that the simulated quiescent output voltage  $V_{outq} = 905 \text{ mV}$  is close to the desired value set at  $V_{outq} = 900 \text{ mV}$ . This means that the OTA is biased in the high gain region and we

actually don't need to extract any offset voltage at this point and can proceed with the simulation of the large-signal characteristic.

The operating point information for all transistors are extracted from the ngspice .op file. The data is split into the large-signal operating informations in Table 5.2, the small-signal operating point informations in Table 5.3 and the noise operating point informations in Table 5.4.

Table 5.2: Operating point information extracted from ngspice .op file for each transistor.

Transistor	$I_D$ [nA]	$I_{spec}$ [nA]	$IC$	$n$	$V_{Dsat}$ [mV]
M1a	250	2355	0.106	1.27	120
M1b	250	2355	0.106	1.27	120
M2a	250	7	38.417	1.31	424
M2b	250	7	38.417	1.31	424
M3a	250	2584	0.097	1.27	120
M3b	250	2584	0.097	1.27	120
M4a	250	2367	0.106	1.31	120
M4b	250	2367	0.106	1.31	120
M5a	500	18	28.507	1.27	380
M5b	500	18	28.507	1.27	380

Table 5.3: Small-signal operating point information extracted from ngspice .op file for each transistor.

Transistor	$n$	$G_{ms}$ [ $\mu A/V$ ]	$G_m$ [ $\mu A/V$ ]	$G_{mb}$ [ $\mu A/V$ ]	$G_{ds}$ [ $nA/V$ ]
M1a	1.27	8.801	7.081	1.709	11.230
M1b	1.27	8.801	7.081	1.709	11.230
M2a	1.31	1.414	1.039	0.374	1.144
M2b	1.31	1.414	1.039	0.374	1.144
M3a	1.27	8.838	7.252	1.548	38.346
M3b	1.27	8.838	7.252	1.548	38.346
M4a	1.31	8.812	6.979	1.813	19.518
M4b	1.31	8.812	6.979	1.813	19.518
M5a	1.27	3.209	2.477	0.717	15.162
M5b	1.27	3.209	2.478	0.717	13.987

Table 5.4: Noise operating point information extracted from ngspice .op file for each transistor.

Transistor	$\gamma_n$	$R_{n,th}$ [k $\Omega$ ]	$V_{n,th}$ [nV/ $\sqrt{Hz}$ ]	$V_{n,fl}$ at 1Hz [ $\mu V/\sqrt{Hz}$ ]
M1a	0.65	91.2	38.9	8.3
M1b	0.65	91.2	38.9	8.3
M2a	0.90	865.2	119.8	70.1
M2b	0.90	865.2	119.8	70.1
M3a	0.63	87.2	38.0	32.7
M3b	0.63	87.2	38.0	32.7
M4a	0.65	93.8	39.4	46.6
M4b	0.65	93.8	39.4	46.6
M5a	0.86	346.5	75.8	21.8
M5b	0.86	346.2	75.8	21.8

We can also check the bias voltages and operating region of each transistor which are given in Table 5.5.



Table 5.5: Bias voltages and operating regions extracted from ngspice for each transistor.

Trans.	Type	Funct.	$V_G$ [V]	$V_S$ [V]	$V_D$ [V]	$V_{DS}$ [mV]	$V_{Dsat}$ [mV]	Reg.	Sat.
M1a	n	DP	0.900	0.402	0.628	227	120	MI	sat
M1b	n	DP	0.900	0.402	0.628	227	120	MI	sat
M2a	p	CM	0.895	0.000	0.536	536	424	SI	sat
M2b	p	CM	0.895	0.000	0.536	536	424	SI	sat
M3a	n	CA	1.200	0.628	0.905	276	120	WI	sat
M3b	n	CA	1.200	0.628	0.905	276	120	WI	sat
M4a	p	CA	1.100	0.536	0.895	360	120	MI	sat
M4b	p	CA	1.100	0.536	0.895	360	120	MI	sat
M5a	n	CM	0.821	0.000	0.399	399	380	SI	sat
M5b	n	CM	0.821	0.000	0.402	402	380	SI	sat

From Table 5.2, we see that all transistors have a sufficiently large  $V_{DS}$  voltage and are therefore biased in saturation. Additionally we see that all the saturation voltages in the output current branch  $M_{2d}$ ,  $M_4$ ,  $M_7$  and  $M_{3b}$  are summing up to  $1164 \text{ mV}$  leaving an output voltage swing about equal to  $V_{out,swing} \cong 636 \text{ mV}$ . This output voltage swing could be increased by about  $250 \text{ mV}$  by biasing  $M_{2d}$  and  $M_{3b}$  in weak inversion. This would be at the cost of larger transistors and a less current matching in the current mirrors.

From Table 5.5, we see that all transistors are biased in saturation. The operating points look fine. We can now proceed with the simulation of the open-loop large-signal transfer characteristic.

## 5.2 Large-signal differential transfer characteristic

We now simulate the DC differential transfer characteristic. The simulation of the large-signal input-output characteristic is presented in Figure 5.1.

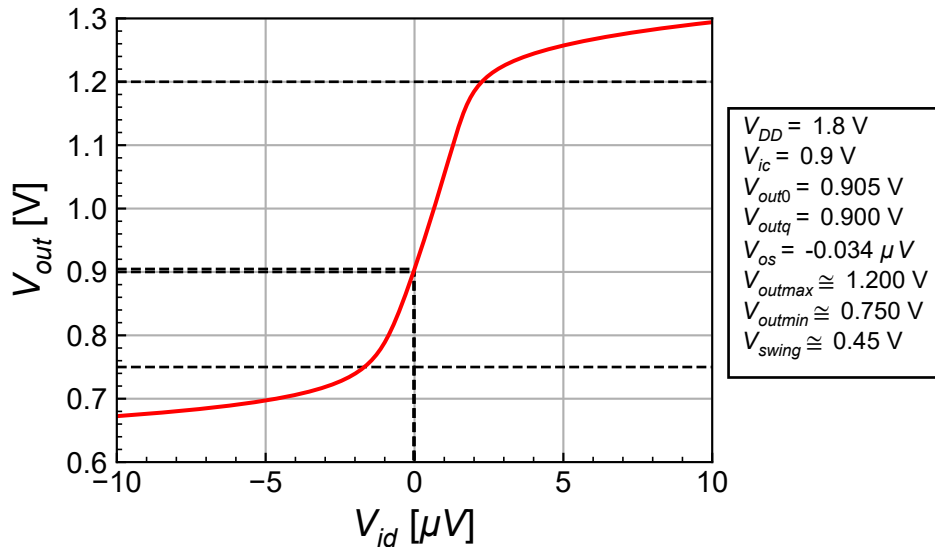


Figure 5.1: Simulated large-signal input-output characteristic.

From Figure 5.1, we see that the output swing is about  $V_{out,swing} \cong 450 \text{ mV}$ , which is even less than the above estimation. We can now zoom into the high gain region in order to extract the offset voltage that is needed to bring the output voltage back to  $V_{outq} = 0.900 \text{ V}$ . The simulation results are presented in Figure 5.2.

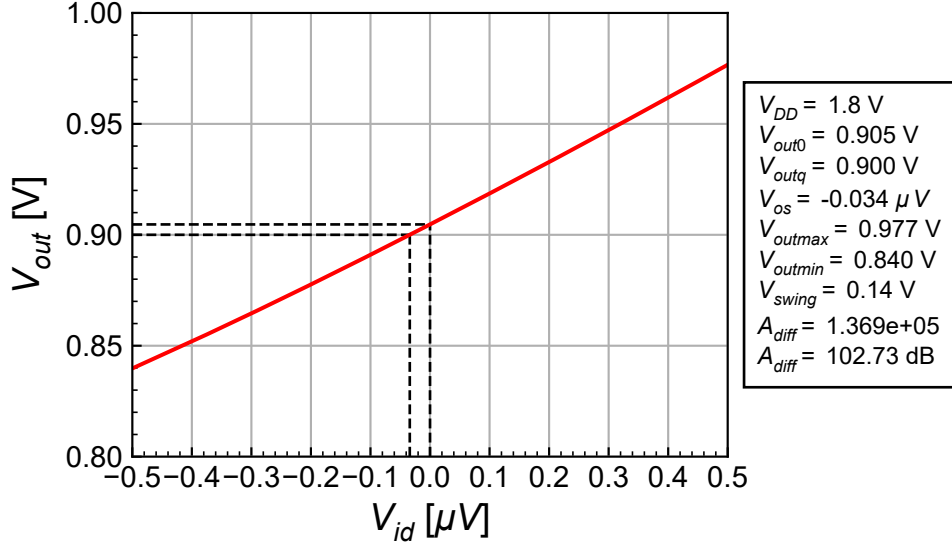


Figure 5.2: Zoom of the simulated large-signal input-output characteristic in the gain region.

We can now save the extracted offset voltage  $V_{os} = -0.034 \mu V$  that is required to bring the output voltage to  $V_{outq} = 0.900 V$  and that will be used for the following .AC and .NOISE simulations.

### 5.3 Open-loop gain

After having checked the operating point information and making sure that the OTA output is not saturated by extracting the required offset voltage for bringing the output operating point to the desired value  $V_{outq} = 0.900 V$ , we can now perform the AC simulation. The open-loop transfer function is shown in Figure 5.3.

From Figure 5.3, we see that the simulated differential gain magnitude is very close to the theoretical estimation. The simulated  $GBW$  is equal to the predicted  $GBW$  and above specification. The simulated DC gain is slightly lower than the theoretical estimation. This difference is obviously due to the poor output conductance model we have used for the design.

### 5.4 Input-referred noise

The simulated input-referred noise PSD is presented in Figure 5.4 and compared to the theoretical estimation.

From Figure 5.4, we see that there is a perfect match between the simulated and estimated input-referred noise PSD for both the white and flicker noise PSD. We also observe that the specification of the corner frequency is met. The discrepancy appearing at high frequency is simply due to the fact that the theoretical input-referred noise was obtained by dividing the output noise current PSD by the square of the equivalent transconductance without accounting for its frequency dependence. We can have a closer look at the contributions of the various transistors to the input-referred noise PSD.

Figure 5.5 shows that the simulated total input-referred white noise PSD perfectly matches the theoretical prediction. Figure 5.5 also shows the contributions of  $M_{1a}$ - $M_{1b}$ ,  $M_{2a}$ - $M_{2b}$ ,  $M_{3a}$ - $M_{3b}$ ,  $M_{4a}$ - $M_{4b}$  and  $M_{5a}$ - $M_{5b}$  to the input-referred white noise PSD. We can observe that the white noise is dominated by the contribution of  $M_{1a}$ - $M_{1b}$ . This is confirmed by the value of the simulated  $\eta_{th} = 0.205$  which is very close to the theoretical value  $\eta_{th} = 0.201$ . The contribution of  $M_{2a}$ - $M_{2b}$  is 6.9 dB lower than the contribution of  $M_{1a}$ - $M_{1b}$ . We also see that the contributions of the cascode transistors

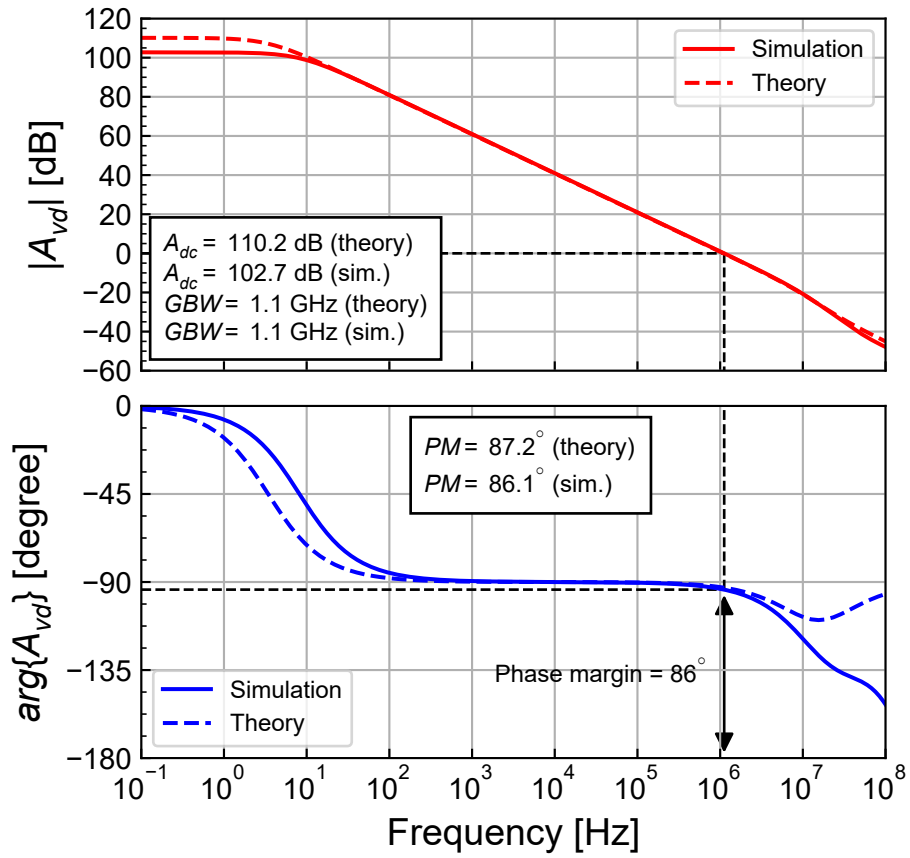


Figure 5.3: Simulated gain response compared to theoretical estimation.

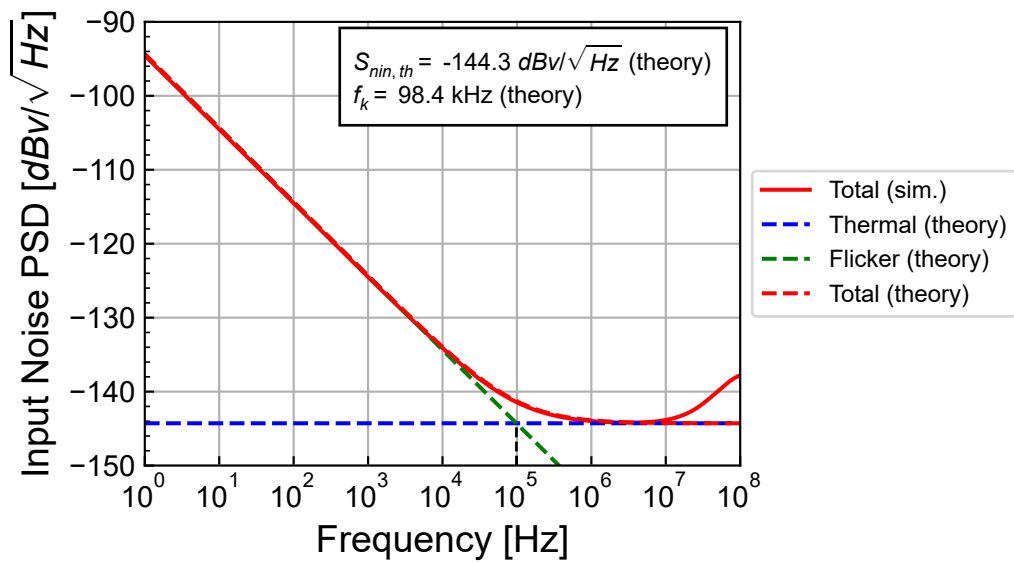


Figure 5.4: Simulated input-referred noise PSD compared to theoretical estimation.

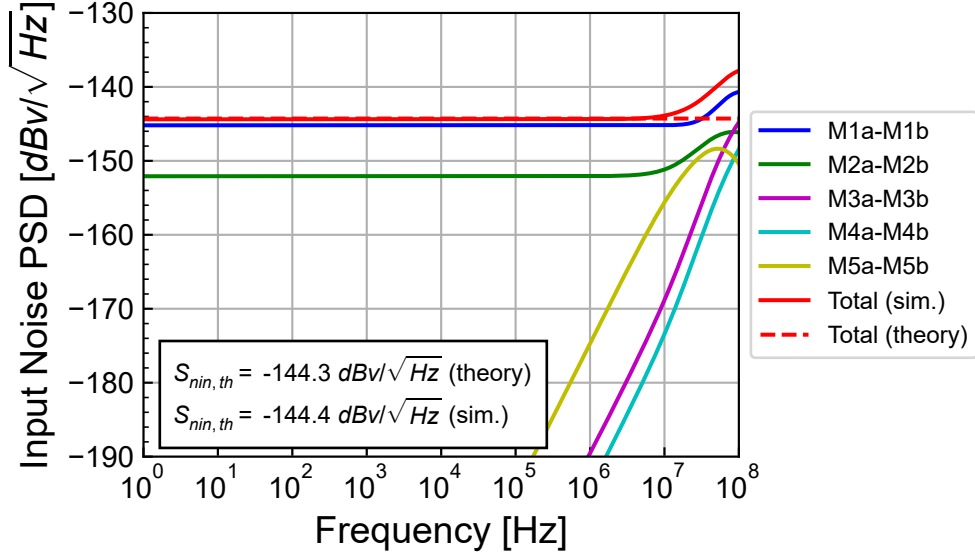


Figure 5.5: Breakdown of the contributions to the simulated input-referred white noise PSD.

$M_{3a}$ - $M_{3b}$  and  $M_{4a}$ - $M_{4b}$  are negligible. The contribution of  $M_{5a}$ - $M_{5b}$  is also negligible since it is a common mode contribution which is cancelled at the output. Finally, the simulated OTA thermal noise excess factor  $\gamma_{n,ota} = 1.558$  is slightly smaller than the predicted value  $\gamma_{n,ota} = 1.569$ .

Figure 5.6 presents the breakdown of the contributions of the various transistors to the input-referred flicker noise.

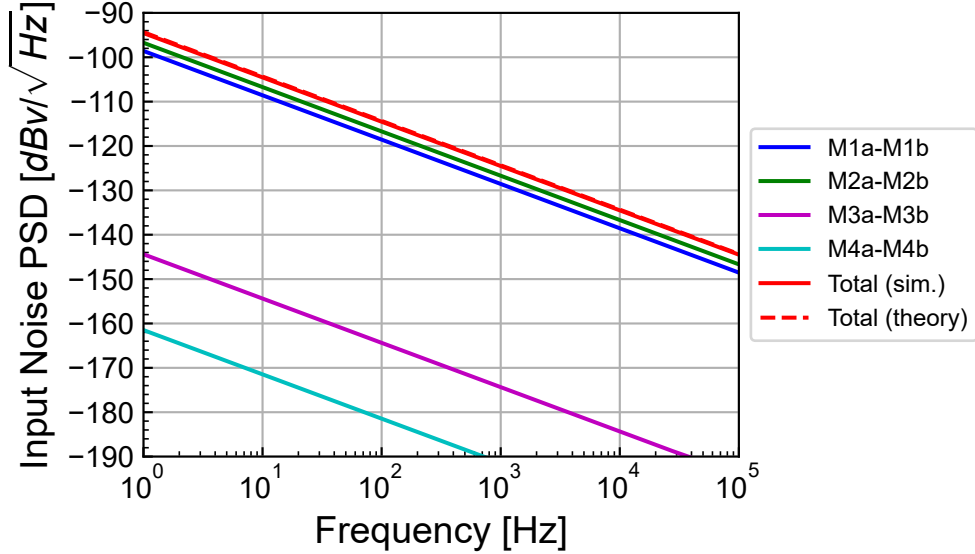


Figure 5.6: Breakdown of the contributions to the simulated input-referred flicker noise PSD.

Similarly to the white noise, Figure 5.6 shows that the total simulated input-referred flicker noise PSD perfectly matches the theoretical prediction. We can observe that the input-referred flicker noise is dominated by the contribution of  $M_{2a}$ - $M_{2b}$  which is 1.845 dB higher than the contribution of  $M_{1a}$ - $M_{1b}$ . This is consistent with the value of  $\eta_{fl} = 1.529$  (1.845 in dB) which is close to the theoretical value  $\eta_{fl} = 1.734$ . We see that  $M_{2a}$ - $M_{2b}$  contribute about the same as  $M_{1a}$ - $M_{1b}$  and that the contributions of the cascode transistors  $M_{3a}$ - $M_{3b}$  and  $M_{4a}$ - $M_{4b}$  are negligible. The contributions of the cascode transistors are negligible. Note that the contribution of  $M_{5a}$ - $M_{5b}$  is not shown because it is completely negligible.

The contributions of the various transistors to the total input-referred noise PSD is shown in Figure 5.7.

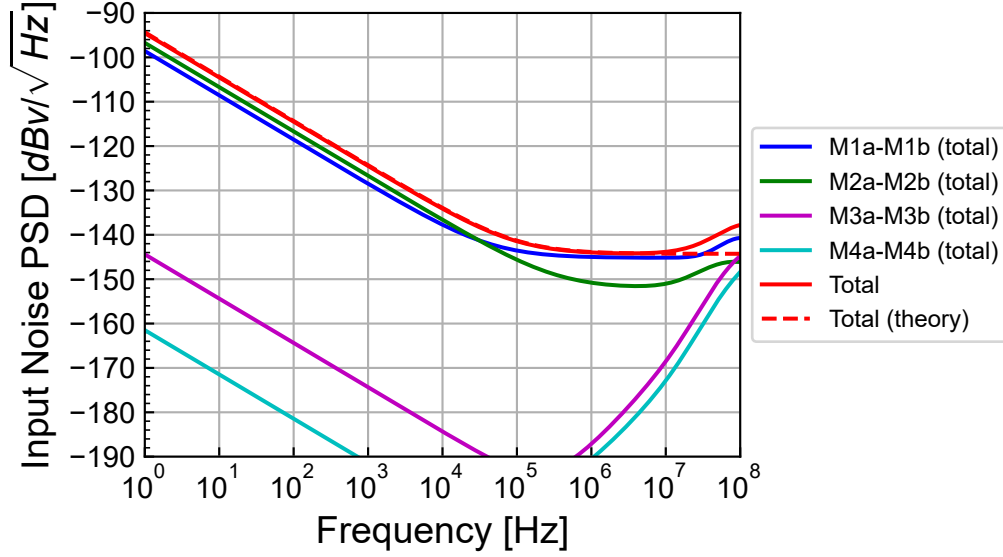


Figure 5.7: Breakdown of the contributions to the simulated input-referred noise PSD.

## 5.5 Input common-mode voltage range

We can check the input common-mode voltage range by connecting the OTA as a voltage follower and sweeping the positive input.

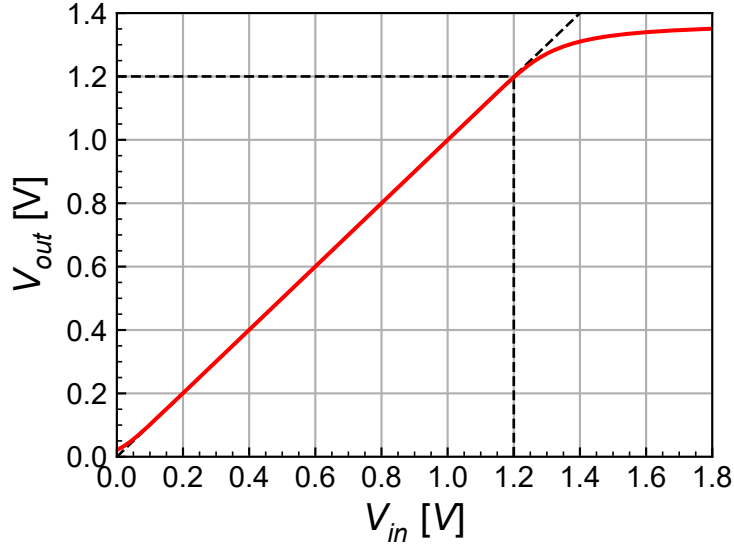


Figure 5.8: Simulated input common-mode voltage range.

As shown in Figure 5.8, the output follows the input voltage up to 1.2 V. So the input common-mode voltage range is about 1.2 V.

## 5.6 Step-response

In this section we will check the step response of the OTA operating as a voltage follower as shown in Figure 5.9 with its output connected to the negative input and with the same load capacitance  $C_L = 1$  pF.

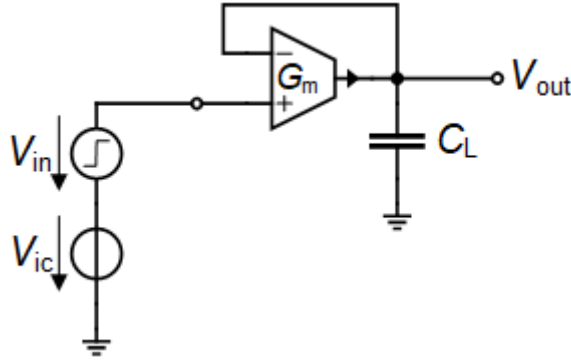


Figure 5.9: Schematic of the OTA connected as a voltage follower.

### 5.6.1 Small-step

According to the input common-mode voltage range established above, we will set the input common-mode voltage to  $V_{ic} = 0.900 \text{ V}$  to make sure that the OTA is in the high gain region. We start by imposing a small step  $\Delta V_{in} = 10 \text{ mV}$  on top of a common mode voltage  $V_{ic} = 0.900 \text{ V}$ . The simulation results are shown in Figure 5.10 where  $\Delta V_{in}(t) \triangleq V_{in+}(t) - V_{ic}$  and  $\Delta V_{out}(t) \triangleq V_{out}(t) - V_{outq}$  with  $V_{outq} \cong V_{ic}$  is the quiescent output voltage.  $\Delta V_{in}$  and  $\Delta V_{out}$  are compared to the response of a single pole circuit having a cut-off frequency equal to the  $GBW$ . From Figure 5.10, we see that the simulation result is very close to the first-order response.

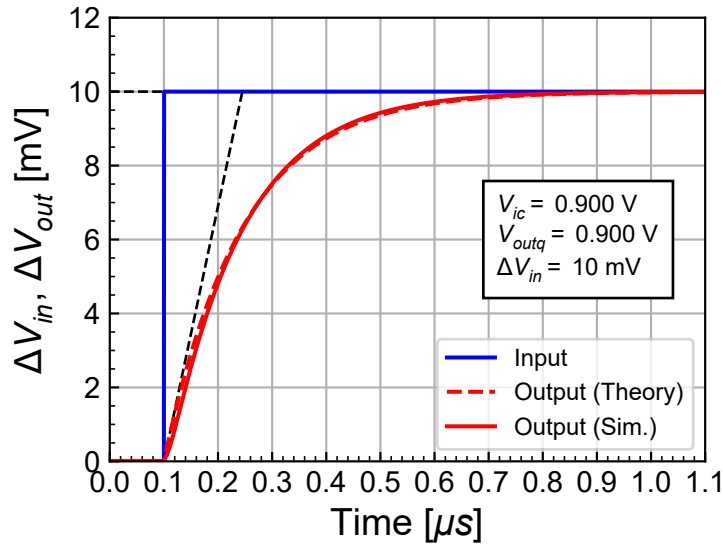


Figure 5.10: Step response of the OTA connected as a voltage follower for a small input step.

### 5.6.2 Large step

Since we now impose a larger step  $\Delta V_{in} = 300 \text{ mV}$ , we need to lower the input common-mode voltage to  $V_{ic} = 800 \text{ mV}$ , to make sure that after the step the OTA remains in the high gain region and correctly settles to the right voltage. The simulation results are shown in Figure 5.11 where  $\Delta V_{in}(t) \triangleq V_{in+}(t) - V_{ic}$  and  $\Delta V_{out}(t) \triangleq V_{out}(t) - V_{outq}$  with  $V_{outq} \cong V_{ic}$  is the quiescent output voltage.  $\Delta V_{in}$  and  $\Delta V_{out}$  are compared to the response of a single pole circuit having a cut-off frequency equal to the  $GBW$ . We now observe the effect of slew-rate which increases the settling time.

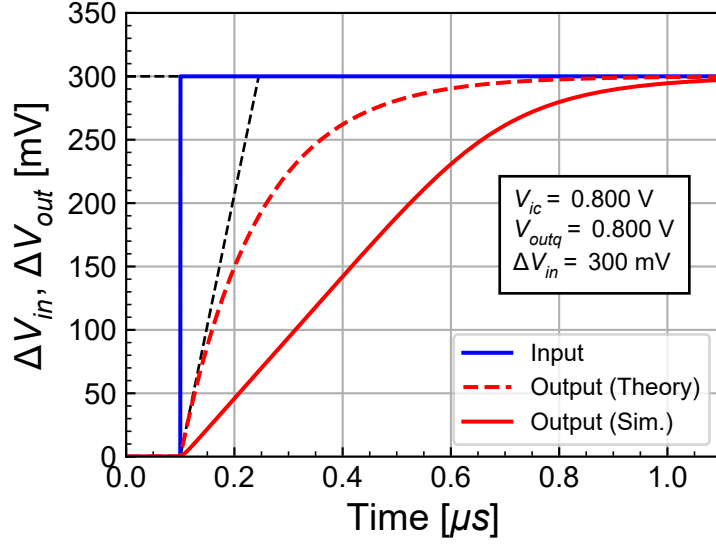


Figure 5.11: Step response of the OTA connected as a voltage follower for a large input step highlighting the slew-rate effect.

## 5.7 Power consumption

The total current consumption, ignoring the current drawn by  $M_{5a}$ , is  $I_{tot} = 2I_b = 0.5 \mu A$  and the total power consumption is then  $P = 0.9 \mu W$ . Assuming the input differential pair  $M_{1a}$ - $M_{1b}$  is biased in deep weak inversion, the minimum bias current is directly related to the gain-bandwidth product  $GBW$  according to

$$I_{b,min} \cong nU_T \cdot C_L \cdot \omega_u = nU_T \cdot C_L \cdot 2\pi GBW = 207 \text{ nA}.$$

The minimum total current consumption can then be estimated as  $I_{tot,min} \cong 2I_{b,min} = 413 \text{ nA}$ . The actual current consumption accounting for some margin taken on the  $GBW$  is therefore 21% higher than the absolute minimum. Note that this increased current consumption is necessary to fight against the parasitic capacitances at the OTA output.

### **i** Note

Note that the telescopic OTA is the differential OTA that has the minimum power consumption for similar gain-bandwidth product, DC gain and phase margin specifications. Of course it has the smallest input and output voltage swings and the DC gain equivalent to the two-stage OTA is hard to achieve at low-voltage.

## 6 Conclusion

This notebook presented the analysis, design and verification of the telescopic OTA [1] designed for a generic 180nm bulk CMOS process. The detailed analysis provided all the equations that were then used in the design phase to reach the target specifications. The design was then performed using the inversion coefficient approach with the sEKV transistor model [2] [3] [4]. The theoretical performance resulting from the design were then evaluated.

The design was then verified by simulation using ngspice [5] with the EKV 2.6 compact model [6] and the parameters of a generic 180 nm bulk CMOS process. After carefully checking the operating point, the large-signal transfer characteristic was simulated. The small-signal open-loop transfer function was then simulated making sure the OTA was biased in the high gain region. The simulated transfer function was very close to the theoretical prediction except for the DC gain which is slightly smaller but still in spec. The simulations have also shown that the gain-bandwidth product  $GBW$  and the DC gain specifications are both achieved.

The input-referred noise was then simulated. The total simulated input-referred noise PSD perfectly matches the theoretical estimation for both the white noise and the flicker noise. The simulations have also shown that the specification on the corner frequency was met. The contributions of the various transistors to the input-referred white noise were then extracted from the noise simulation and compared to the theoretical estimation. It was shown that the total white noise is very close to the theoretical estimation. The simulation of the input-referred flicker noise have shown that it is dominated by the current mirror  $M_{2a}$ - $M_{2b}$ . Finally, the simulations have confirmed that the noise contributions of the cascode transistors are completely negligible.

The input common-mode voltage range was then simulated with the OTA connected as a voltage follower. The input voltage is limited to 1.2 V.

Finally, the small-signal step response was simulated and successfully compared to the response of a single-pole system. The step-response with a large input step highlighted the effect of slew-rate.

The telescopic OTA is the most power efficient differential OTA among those we have studied. This efficiency comes at the cost of a reduced input and output voltage swing and lower DC gain at lower supply voltage.



# References

- [1] B. Razavi, *Design of Analog CMOS Integrated Circuits*, 2nd ed. Mc-Graw-Hill, 2017.
- [2] C. C. Enz and E. A. Vittoz, *Charge-Based MOS Transistor Modeling - The EKV Model for Low-Power and RF IC Design*, 1st ed. John Wiley, 2006.
- [3] C. Enz, F. Chicco, and A. Pezzotta, “Nanoscale MOSFET Modeling: Part 1: The Simplified EKV Model for the Design of Low-Power Analog Circuits,” *IEEE Solid-State Circuits Magazine*, vol. 9, no. 3, pp. 26–35, 2017.
- [4] C. Enz, F. Chicco, and A. Pezzotta, “Nanoscale MOSFET Modeling: Part 2: Using the Inversion Coefficient as the Primary Design Parameter,” *IEEE Solid-State Circuits Magazine*, vol. 9, no. 4, pp. 73–81, 2017.
- [5] Holger Vogt, Giles Atkinson, Paolo Nenzi, “Ngspice User’s Manual Version 43.” <https://ngspice.sourceforge.io/docs/ngspice-43-manual.pdf>, 2024.
- [6] M. Bucher, C. Lallement, C. Enz, F. Théodoloz, and F. Krummenacher, “The EPFL-EKV MOSFET Model Equations for Simulation.” [https://github.com/chrisenz/EKV/blob/main/EKV2.6/docs/ekv\\_v26\\_rev2.pdf](https://github.com/chrisenz/EKV/blob/main/EKV2.6/docs/ekv_v26_rev2.pdf), 1998.
- [7] M. Bucher, C. Lallement, C. Enz, F. Théodoloz, and F. Krummenacher, “EKV 2.6 Verilog-A Code.” <https://github.com/chrisenz/EKV/tree/main/EKV2.6/va/code>, 2024.
- [8] W. Grabinski *et al.*, “FOSS EKV2.6 verilog-a compact MOSFET model,” in *European solid-state device research conference (ESSDERC)*, 2019, pp. 190–193. doi: [10.1109/ESSDERC.2019.8901822](https://doi.org/10.1109/ESSDERC.2019.8901822).
- [9] W. Grabinski *et al.*, “FOSS EKV 2.6 parameter extractor,” in *2015 22nd international conference mixed design of integrated circuits & systems (MIXDES)*, 2015, pp. 181–186. doi: [10.1109/MIXDES.2015.7208507](https://doi.org/10.1109/MIXDES.2015.7208507).
- [10] Han, H.-C. and A. D’Amico and C. Enz, “SEKV-E: Parameter Extractor of Simplified EKV I-V model for Low-power Analog Circuits.” <https://gitlab.com/moscm/sekv-e>, 2022.
- [11] F. Krummenacher, E. Vittoz, and M. Degrauwe, “Class AB CMOS amplifier micropower SC filters,” *Electronics Letters*, vol. 17, no. 13, pp. 433–435, 1981.
- [12] M. G. Degrauwe, J. Rijmenants, E. A. Vittoz, and H. J. D. Man, “Adaptive biasing CMOS amplifiers,” *IEEE Journal of Solid-State Circuits*, vol. 17, no. 3, pp. 522–528, 1982.
- [13] C. C. Enz, F. Krummenacher, and E. A. Vittoz, “An Analytical MOS Transistor Model Valid in All Regions of Operation and Dedicated to Low-Voltage and Low-Current Applications,” *Analog Integrated Circuits and Signal Processing Journal*, vol. 8. [https://github.com/chrisenz/EKV/tree/main/EKV2.6/docs/EKV\\_original\\_paper\\_1995\\_prepub.pdf](https://github.com/chrisenz/EKV/tree/main/EKV2.6/docs/EKV_original_paper_1995_prepub.pdf), pp. 83–114, 1995.
- [14] Dietmar Warning, “Verilog-A Models for Circuit Simulation.” <https://github.com/dwarning/VA-Models>, 2024.
- [15] SemiMod GmbH, “Open VAF.” <https://openvaf.semimod.de/docs/getting-started/introduction/>, 2025.